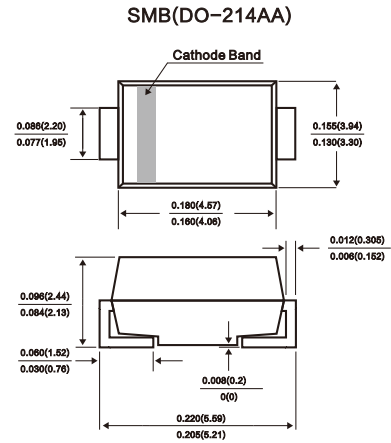


**FEATURES**

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Metal silicon junction ,majority carrier conduction
- For surface mount applications
- Low power loss ,high efficiency
- High current capability ,Low forward voltage drop
- Low profile package
- built-in strain relief ,ideal for automated placement
- For use in low voltage ,high frequency inverters, free wheeling ,and polarity protection applications
- High temperature soldering guaranteed:260°C/10 seconds at terminals

**MECHANICAL DATA**

- Case: JEDEC SMB(DO-214AA) molded plastic body
- Terminals: solder plated ,solderable per MIL-STD-750,method 2026
- Polarity: color band denotes cathode end
- Weight: 0.003ounce,0.093 gram



Dimensions in inches and (millimeters)

**MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS**

(Ratings at 25°C ambient temperature unless otherwise specified ,Single phase ,half wave ,resistive or inductive load. For capacitive load,derate by 20%.)

	Symbols	SS 32	SS 33	SS 34	SS 35	SS 36	SS 38	SS 310	SS 315	SS 320	Volts
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	20	30	40	50	60	80	100	150	200	Volts
Maximum RMS voltage	V <sub>RMS</sub>	14	21	28	35	42	57	71	105	140	Volts
Maximum DC blocking voltage	V <sub>DC</sub>	20	30	40	50	60	80	100	150	200	Volts
Maximum average forward rectified current 0.375"(9.5mm) lead length (See Fig.1)	I(AV)	3.0									Amps
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	I <sub>FSM</sub>	80.0									Amps
Maximum instantaneous forward voltage at 3.0 A(Note 1)	V <sub>F</sub>	0.55			0.75		0.85		0.90	0.95	Volts
Maximum instantaneous reverse current at rated DC blocking voltage(Note 1)	I <sub>R</sub>	0.2									mA
		20			10						
Typical junction capacitance(Note 3)	C <sub>J</sub>	250			160						pF
Typical thermal resistance (Note 2)	R <sub>θJA</sub> R <sub>θJL</sub>	55.0									°C/W
		17.0									
Operating junction temperature range	T <sub>J</sub>	-65 to+150									°C
Storage temperature range	T <sub>STG</sub>	-65 to+150									°C

- Notes: 1.Pulse test: 300 μs pulse width,1% duty cycle  
 2. P.C.B. mounted 0.55 X 0.55"(14 X 14mm)copper pad areas  
 3. Measured at 1MHz and reverse voltage of 4.0volts

FIG.1-FORWARD CURRENT DERATING CURVE

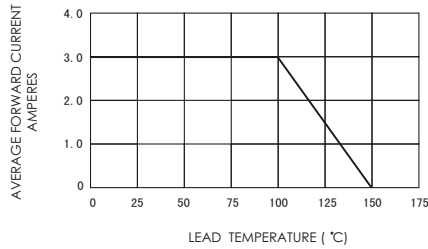


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

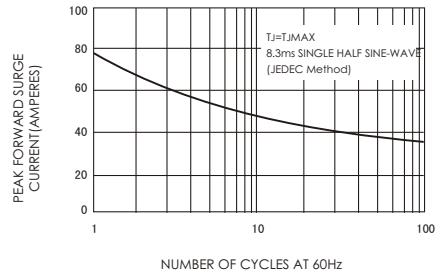


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

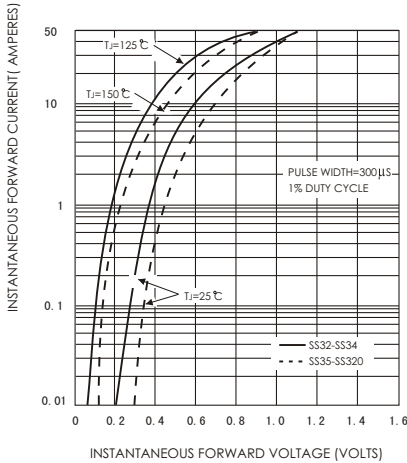


FIG.4-TYPICAL REVERSE CHARACTERISTICS

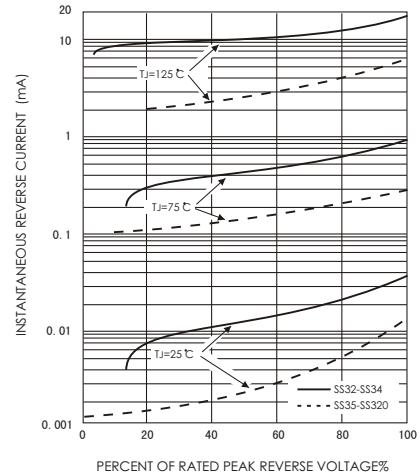


FIG.5-TYPICAL JUNCTION CAPACITANCE

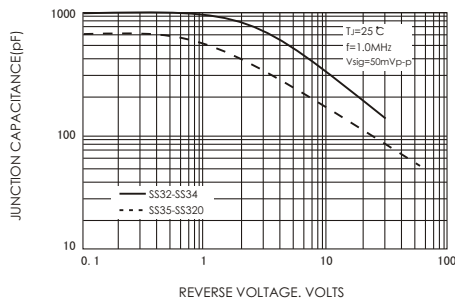


FIG.6-TYPICAL TRANSIENT THERMAL IMPEDANCE

